# **Specifications for Approval**

Customer Part No.:

	Inhere Part No	.: LY936A3-001			
	Part Name: 球头小蝴蝶水清透明黄光 LED Spec Issue Date: 2018-08-13 Revision No.: A				
========	:=========				
■ Sample ■ Electrica	erewith the followi	urve Internal Circui	LED Dimension		
Prepared by	•	Checked by: Tom	Approved by: Wangxiaojun		
Prepared by Date: 2018-0	•	Checked by: Tom Date: 2018-08-13	Approved by: Wangxiaojun Date: 2018-08-13		



东莞市银河光电有限公司 DongGuan Inhere Opto CO.,LTD. 地址:东莞市莞城科技园 D 幢 ADD:Guancheng Science & Technology Park, DongGuan TEL: 0769-23320868 FAX: 0769-23320878

E-mail: bill@inhereopto.com Http://www.inhereopto.com

# **SPECIFICATIONS**

## **Features**

- High speed response.
- High reliability and long life.
- Low power consumption.
- Available in red, orange, yellow, yellow-green, green, blue, white, pink\*
- Suitable for pulse operation.
- RoHS compliant.

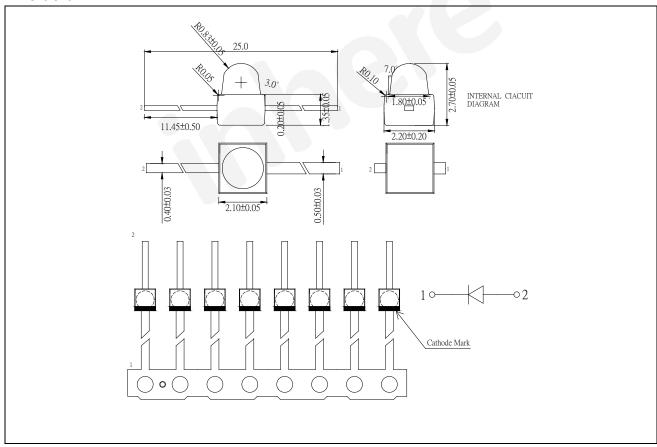
# Description

The Yellow source color devices are made with AlGaInP on GaAs Light Emitting Diode.

# **Applications**

- Automotive: Dashboards, stop lamps,
- Backlighting: LCDs, Key pads advertising
- Status indicators: Consumer & industrial electronics.
- General use

## **Dimensions**



### Notes:

Prepared by: Lily

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25 (0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

Part No.: LY936A3-001

Rev.: A Checked by: Tom Date: 2018-08-13 Approved by: Wangxiaojun

# **Selection Guide**

	Dice	Emitting Color	Lens Type	I <sub>V</sub> (mcd) @ 20mA			Viewing Angle(°)	
Part No.				Min.	Тур.	Max.	$2\theta_{\frac{1}{2}}$	
LY936A3-001	AlGaInP	Yellow	Water Clear	800	1700		35	

#### Note:

- $1.\, heta_{\frac{1}{2}}$  is the angle from optical centerline where the luminous intensity is  $\,\frac{1}{2}\,$  the optical centerline value.
- 2. The tolerance of luminous intensity (Iv ) is  $\pm 15\%$ .

Electrical / Optical Characteristics (at  $T_a = 25^{\circ}C$ )

	Symbol	Value					
Parameter		Min.	Тур.	Max.	Unit	Test Condition	
Forward Voltage	$V_{\rm F}$	1.8	2.0	2.6	V	I <sub>F</sub> = 20mA	
Dominant Wavelength	$\lambda_{_{\mathrm{D}}}$	585		595	nm	I <sub>F</sub> = 20mA	
Reverse Current	$I_R$			10	μА	V <sub>R</sub> = 5V	
Spectral Line Half Width	Δλ		15	~~ C	nm	I <sub>F</sub> = 20mA	

## Note:

- 1.The tolerance of forward voltage is  $\pm\,$  0.05V..
- 2. The tolerance of dominant wavelength is ±1nm.
- 3. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

Absolute Maximum Ratings (at  $T_a = 25$ °C)

Parameter	Symbol	Value	Unit
Power Dissipation	$P_{D}$	95	mW
Peak Forward Current *1	$I_{\mathrm{FP}}$	100	mA
Forward Current	$I_{\mathrm{F}}$	30	mA DC
Reverse Voltage	$V_R$	5	V DC
Operating Temperature	$T_{ m opr}$	-40~ +85	°C
Storage Temperature	$T_{ m stg}$	-40~ +100	°C
Soldering Temperature	$T_{\rm sol}$	260°C for	5 sec 3 times

 $<sup>\,</sup>$   $\!\!$   $\!\!$   $\!\!$   $\!\!$  1 Condition for IFP is pulse of 1/10 duty and 0.1msec width.

Part No.: LY936A3-001 Rev.: A Date: 2018-08-13
Prepared by: Lily Checked by: Tom Approved by: Wangxiaojun

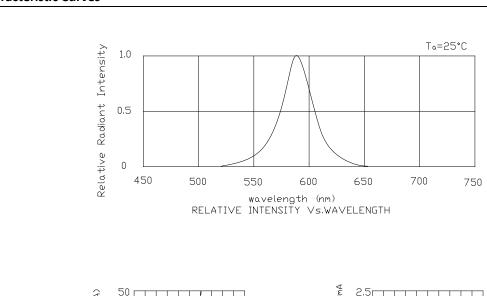
**Reliability Testing Conditions** 

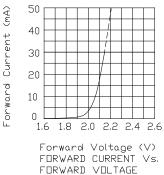
Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS-C-7021:B-1	Ta: Under room temperature  Test time:1,000hrs  IF= Product Recommended IF	0/32
	High Temperature High Humidity Storage	MIL-STD-202F:103B JIS-C-7021:B-11	Ta:85±5°C RH:90%-95% Test time:240hrs	0/32
	MIL-STD-883:1008 High Temperature Storage JIS-C-7021:B-10		Ta:100±5℃ Test time:1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021:B-11	Ta:-40±5℃ Test time:1,000hrs	0/32
Environmental Test	Temperature Cycling	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS-C-7021:A-2	Ta: -40 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C $\sim$ 25 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C $\sim$ 100 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C $\sim$ 25 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C $\rightarrow$ 30min 5min 30min 5min	0/32
	Thermal Chock	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(95) MIL-STD-883D:1011(1991)	Ta: $-40$ $^{\circ}$ $\pm$ 5 $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ 10min 10min Time:20min/cycle 10cycle	0/32
	Wetting balance	MIL-STD-883:2003 MIL-STD-202F:208D MIL-STD-883D:2003	Ta: 230℃±5℃ Time:5±0.5s	0/32
	Solder Resistance	MIL-STD-202F:210A MIL-STD-883D:1011 JIS-C-7021:A-1	Ta: 260 °C ± 10 °C Time:10 ± 1s	0/32

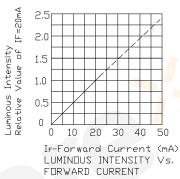
Part No.: LY936A3-001 Prepared by: Lily

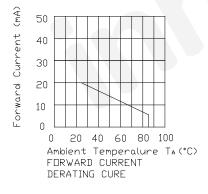
Rev.: A Checked by: Tom Date: 2018-08-13 Approved by: Wangxiaojun

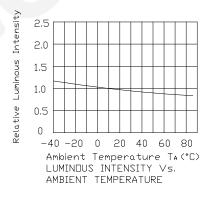
## **Characteristic Curves**

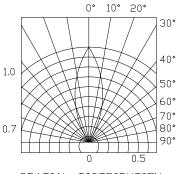






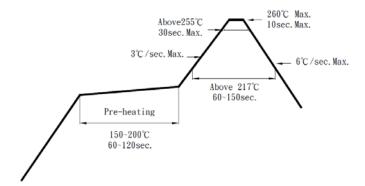






SPATIAL DISTRIBUTION

## **IR-Reflow Soldering**



- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
- 3. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

## **IRON Soldering**

350°C Within 3 sec., One time only.

# Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the Inhere LEDs within the rated figures. Also, caution should be taken not to overload Inhere LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be

# Storage:

In order to avoid the absorption of moisture, it is recommended to solder Inhere LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

designed so as be subjected to reverse voltage when turning off the Inhere LEDs.

- (1) Temperature: 5°C-30°C; Humidity: RH 60%Max.
- (2) After this bag is opened, devices that will be applied to infrared refold, vapor-phase refold, or equivalent soldering process must be:
- a. Completed within 168 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
- (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions:
- 48 hours at 60°C±3°C.

Part No.: LY936A3-001 Rev.: A Date: 2018-08-13
Prepared by: Lily Checked by: Tom Approved by: Wangxiaojun